

BTA45-800B 4Q Triac Rev.04 - 28 May 2019

**Product data sheet** 

### **1. General description**

Planar passivated four quadrant triac in a IITO3P package intended for use in circuits where high static and dynamic dV/dt and high dI/dt can occur. This triac will commutate the full RMS current at the maximum rated junction temperature ( $T_{j(max)} = 150$  °C). It is used in applications where "high junction operating temperature capability" is required.

### 2. Features and benefits

- High current TRIAC
- Low thermal resistance
- High junction operating temperature capability (T<sub>j(max)</sub> = 150 °C)
- High voltage capability
- Planar passivated for voltage ruggedness and reliability
- Insulated tab rated at 2500 V rms

### **3. Applications**

- High current / high surge applications
- High power / industrial controls -- e.g. heating, motors, lighting

### 4. Quick reference data

Symbol	Parameter	Conditions	Values	Unit
Absolute	maximum rating			·
$V_{\text{DRM}}$	repetitive peak off-state voltage		800	V
$\mathbf{I}_{\mathrm{T(RMS)}}$	RMS on-state current	full sine wave; T <sub>mb</sub> ≤ 96 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	45	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	450	A
		full sine wave; $t_p$ = 16.7 ms; $T_{j(init)}$ = 25 °C	495	А
T <sub>i</sub>	junction temperature		150	°C

4Q Triac

Symbol	Parameter	Conditions	IV	lin	Тур	Max	Unit
Static cha	racteristics	· · · · ·					
I <sub>GT</sub>	gate trigger current	$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G+ T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-		-	50	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2+ G- T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-		-	50	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-		-	50	mA
		$V_{D}$ = 12 V; I <sub>T</sub> = 0.1 A; T2- G+ T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-		-	70	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-		-	80	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 63.6 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-		1.3	1.6	V
Dynamic	characteristics	· · · · · ·			1		
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 536 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	7	50	-	-	V/µs
		$V_{DM}$ = 536 V; T <sub>j</sub> = 150 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	5	00	-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	2	0	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1	0	-	-	A/ms

### **5. Pinning information**

	Pinning infor			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T1	main terminal 1	$\bigcirc$	
2	T2	main terminal 2		
3	G	gate	-	sym051
mb	n.c.	mounting base; isolated		

# 6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BTA45-800B	IITO3P	BTA45-800BQ	Tube	30	SOT1292	21-Jul-2017		

# 7. Marking

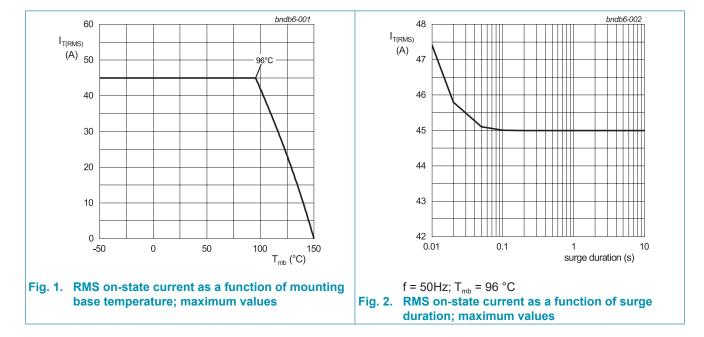
Table 4. Marking codes	
Type number	Marking codes
BTA45-800B	BTA45-800B

# 8. Limiting values

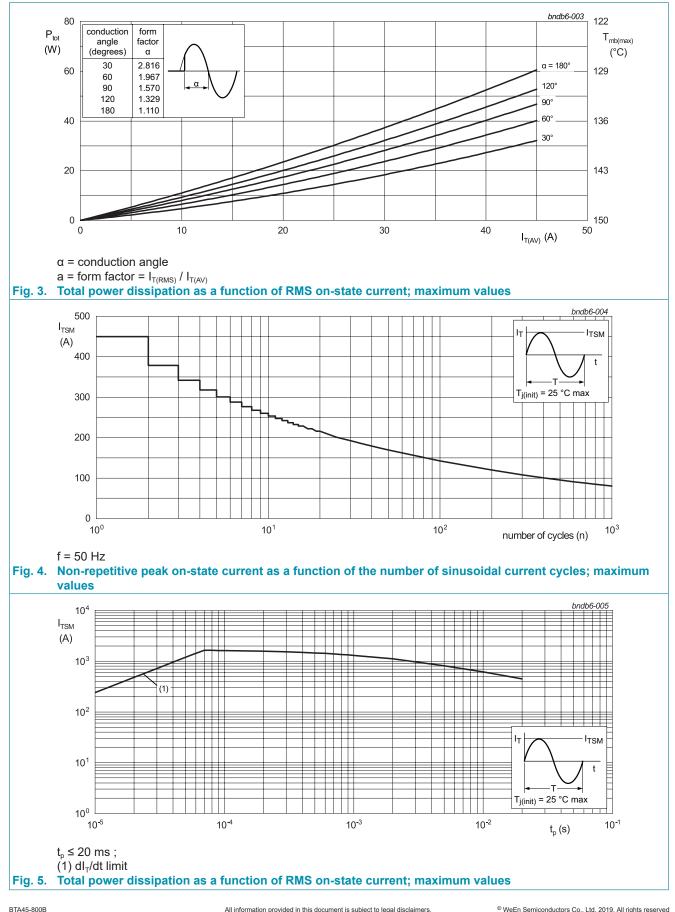
#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage		800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>mb</sub> ≤ 96°C; <u>Fig. 1; Fig. 2; Fig. 3</u>	45	A
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $t_p$ = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	450	A
		full sine wave; $t_p$ = 16.7 ms; $T_{j(init)}$ = 25 °C;	495	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10ms; sine wave	1012.5	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 150mA	150	A/µs
I <sub>GM</sub>	peak gate current	t <sub>p</sub> = 20µs	8	А
P <sub>GM</sub>	peak gate power	t <sub>p</sub> = 20µs	40	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	1	W
T <sub>stg</sub>	storage temperature		-40 to 150	°C
T <sub>j</sub>	junction temperature		150	°C

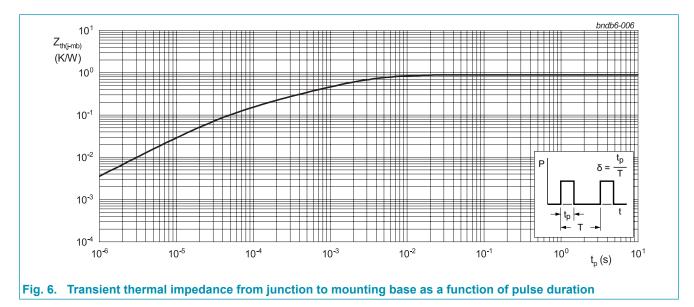


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## 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	-	0.9	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W



# 10. Isolation characteristics

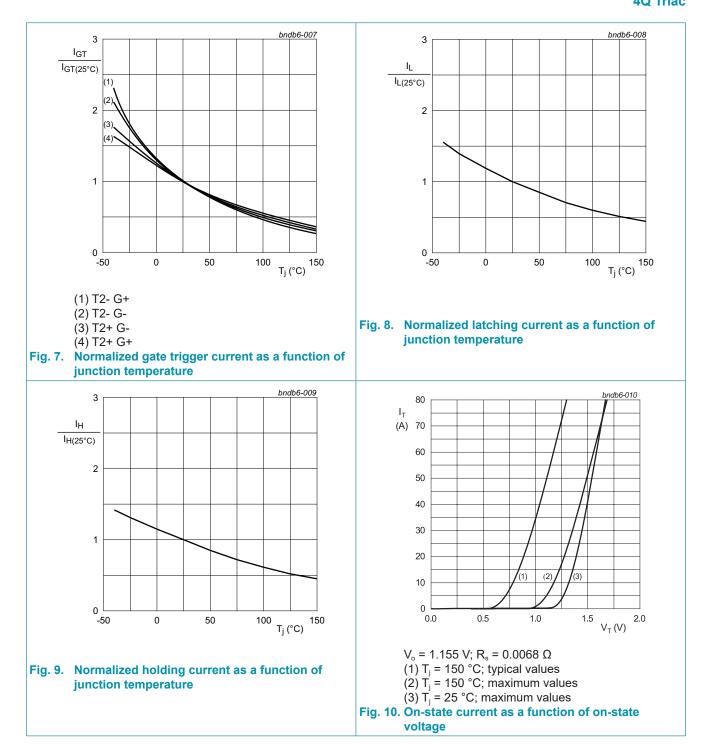
Symbol	Plation characteristics Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	from all terminal to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; T <sub>h</sub> = 25 °C	-	-	2500	V

## **11. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · ·	I			
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	-	50	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G-};$ T <sub>j</sub> = 25 °C; Fig. 7	-	-	50	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	-	50	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	-	70	mA
IL	latching current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	100	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	160	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	100	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	100	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	80	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 63.6 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
V <sub>GT</sub>	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; Fig. 11	-	0.8	1.3	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 150 °C; <u>Fig. 11</u>	0.2	0.45	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>D</sub> = 800 V; T <sub>j</sub> = 150 °C	-	-	2.5	mA
Dynamic o	characteristics	· · · ·	I			_
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 536 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit	750	-	-	V/µs
		$V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 150 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$	500	-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$      V_{\text{D}} = 400 \text{ V};  \text{T}_{\text{j}} = 125 \text{ °C};  \text{I}_{\text{T(RMS)}} = 20\text{A}; \\       dV_{\text{com}}/dt = 20 \text{ V/} \mu\text{s}; \text{ gate open circuit} $	20	-	-	A/ms
		$V_D = 400 \text{ V};  \text{T}_\text{j} = 150 \text{ °C};  \text{I}_{\text{T(RMS)}} = 20\text{ A};$ $dV_{\text{com}}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	10	-	-	A/ms

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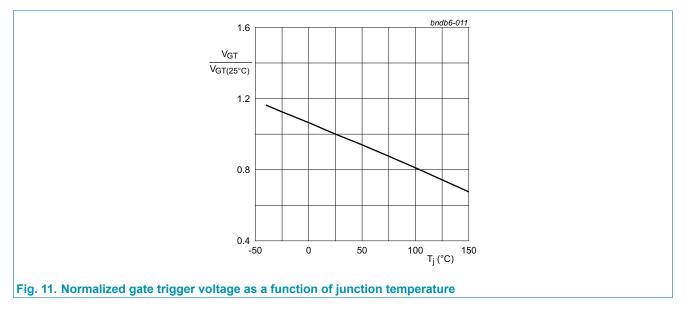
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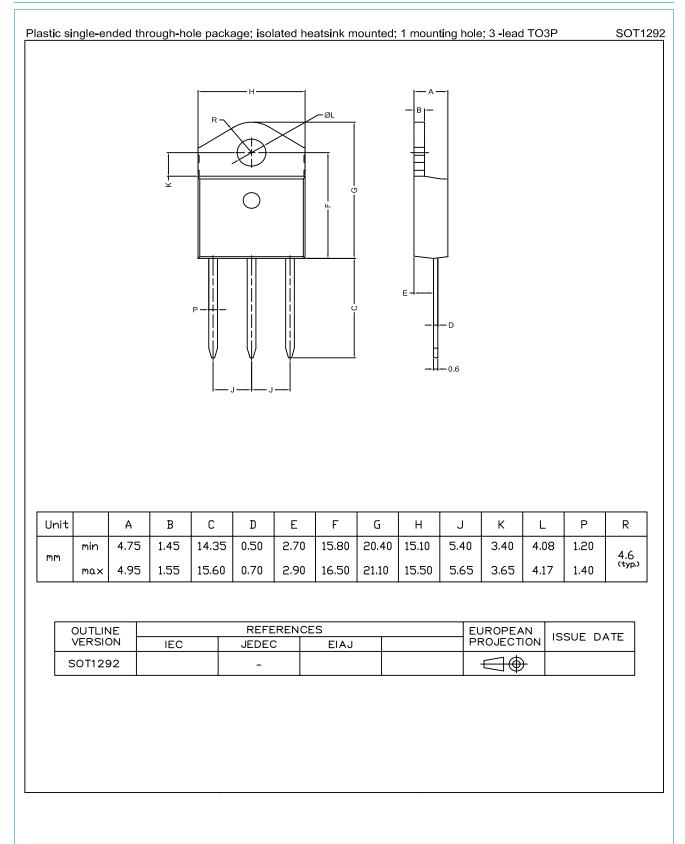
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# BTA45-800B

4Q Triac



## 12. Package outline



# 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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